

|                                   |  |                         |   |  |
|-----------------------------------|--|-------------------------|---|--|
| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination<br>10/554,222 MIYAMA ET AL. |  |
|                                   |  | Examiner                | Art Unit  | Page 1 of 1<br>Alix Elizabeth Echelmeyer |

#### U.S. PATENT DOCUMENTS

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name           | Classification |
|---|---|--|-----------------|----------------|----------------|
| * | A | US-7,214,756                                     | 05-2007         | Nomura et al.  | 528/30         |
| * | B | US-2004/0197613                                  | 10-2004         | Curlier et al. | 429/014        |
|   | C | US-  |                 |                |                |
|   | D | US-  |                 |                |                |
|   | E | US-  |                 |                |                |
|   | F | US-  |                 |                |                |
|   | G | US-  |                 |                |                |
|   | H | US-  |                 |                |                |
|   | I | US-  |                 |                |                |
|   | J | US-  |                 |                |                |
|   | K | US-  |                 |                |                |
|   | L | US-  |                 |                |                |
|   | M | US-  |                 |                |                |

#### FOREIGN PATENT DOCUMENTS

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name          | Classification |
|---|---|--|-----------------|---------|---------------|----------------|
|   | N | WO03/041091                                      | 10-2003         | WIPO    | Nomura et al. |                |
|   | O | JP 2002-309016                                   | 10-2002         | Japan   | Honma et al.  |                |
|   | P |  |                 |         |               |                |
|   | Q |  |                 |         |               |                |
|   | R |  |                 |         |               |                |
|   | S |  |                 |         |               |                |
|   | T |  |                 |         |               |                |

#### NON-PATENT DOCUMENTS

|   |   |   |
|---|---|---|
| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|   | U |   |
|   | V |   |
|   | W |   |
|   | X |   |

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.